

Horizons

S&P Global
Energy

451 Research Market
Insight Report Reprint

Data center infrastructure is rapidly evolving to meet AI workload demands

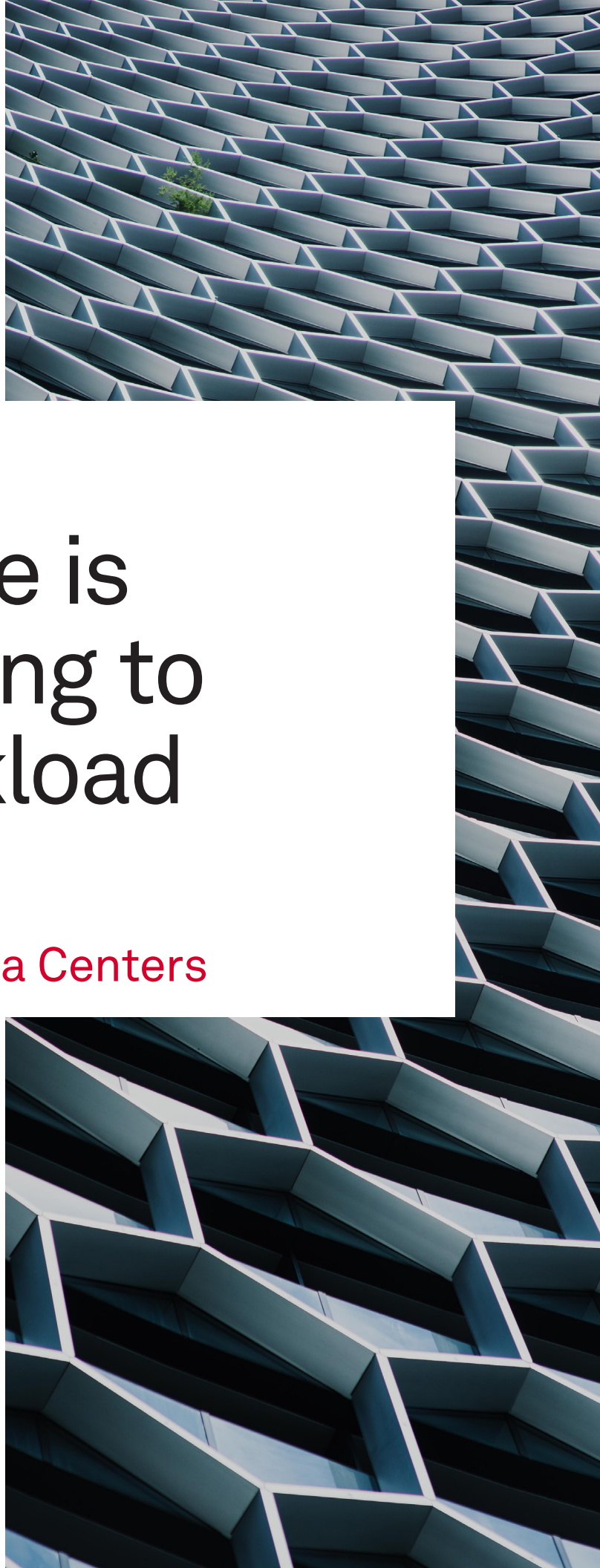
Highlights from **VotE: Data Centers**

February 4, 2026

by **Perkins Liu**

Data center infrastructure is rapidly evolving to meet the demands of large-scale, high-density AI workloads, pushing operators to explore new technologies and energy solution options. In this survey, Voice of the Enterprise: Data Centers, AI Data Centers 2026, we seek to understand key dynamics driving the data center market.

This report, licensed to AMD, developed and as provided by S&P Global Energy (S&P), was published as part of S&P's syndicated market insight subscription service. It shall be owned in its entirety by S&P. This report is solely intended for use by the recipient and may not be reproduced or re-posted, in whole or in part, by the recipient without express permission from S&P.



Introduction

Data center infrastructure is rapidly evolving to meet the demands of large-scale, high-density AI workloads. To support these requirements, the entire industry is actively exploring innovative technologies such as high-voltage DC power distribution for improved energy efficiency, solid-state transformers for enhanced power conversion and flexibility, and advanced liquid-cooling systems to effectively manage the increased heat generated by AI hardware. In 451 Research's Voice of the Enterprise: Data Centers, AI Data Centers 2026 survey, we seek to understand the key dynamics driving the data center market.

The survey, conducted from Nov. 4, 2025, through Dec. 30, 2025, with a panel of 985 IT decision-makers, focused on the adoption of new technologies, including $\pm 400V$ or $800V$ DC, SSTs, energy storage and liquid cooling to address AI workload challenges.

THE TAKE

The evolution of data center infrastructure is being shaped by the rapid growth of AI workloads, pushing operators to adopt advanced technologies. The industry shows strong momentum toward the adoption of high-voltage DC power distribution and solid-state transformers (SSTs), with nearly 95% of organizations expressing a high likelihood of adopting these innovations once they become widely available. This enthusiasm persists despite notable challenges, including high deployment costs, system complexity and internal skills shortages. In response to the surge in GPU workloads, operators are implementing a variety of energy storage solutions at multiple points along the power chain. To address the demands of high-density environments, a diverse mix of cooling technologies remains in use, with many organizations adopting a pragmatic combination of liquid and air cooling — particularly in direct-to-chip installations — to optimize heat management.

Summary of findings

A significant majority of organizations are enabling AI workloads within their data centers. Regarding their readiness to support AI workloads, 63% of respondents indicate that their data center infrastructure already supports AI applications. Additionally, 19% plan to implement support within the next 12 months and 7% expect to do so within two years. Only 12% of respondents report having no plans to support AI workloads over the next two years.

High-voltage DC power systems, such as $\pm 400V$ or $800V$ DC, are expected to see widespread adoption in AI data centers over the next three years. According to survey responses, 46% of participants expect these high-voltage DC solutions to be widely available in AI data centers within 1 year, 37% within 2 years and 12% within 3 years. Regarding the likelihood of their own organizations adopting high-voltage DC if it becomes widely available, 64% of respondents indicate they are very likely to do so. In comparison, 32% say they are somewhat likely — totaling more than 95% expressing a strong inclination toward adoption. The primary obstacles to adopting high-voltage DC in data centers include the high cost of deploying DC components, cited by 60% of respondents. Other significant challenges are the complexity of fault protection mechanisms, such as managing arc flash risks (45%), a lack of internal expertise to support ongoing operation and maintenance (43%) and limited compatibility with existing servers and components (41%).

SSTs are also expected to achieve widespread adoption in AI data centers over the next three years.

Survey results show that 46% of participants anticipate SSTs will be widely available in AI data centers within 1 year, 37% within 2 years and 12% within 3 years. Regarding the likelihood of their own organizations adopting high-voltage DC if it becomes widely available, 60% of respondents indicate they are very likely to do so. In comparison, 35% say they are somewhat likely — bringing the total to nearly 95% and indicating a strong inclination toward adoption. The main obstacles to deploying high-voltage DC and SSTs in data centers include the high cost of SST components (63%), complexity in system design — such as higher voltage integration and fault isolation (50%), an internal skills gap for supporting operation and maintenance (49%) and a lack of organizational buy-in for deployment (34%).

To manage the surge in GPU workloads, operators are implementing a range of solutions across various points in the power chain.

Regarding the energy storage technologies used to address these power surges, 62% of respondents report deploying hybrid systems, such as combinations of supercapacitors with batteries or flywheels. Additionally, 52% use battery energy storage systems, 44% have dynamic voltage restorers or active power conditioners, and 37% use supercapacitors or ultracapacitors. Regarding the placement of energy storage solutions within the power distribution chain, 54% of respondents install them at the power supply unit, 44% at the medium-voltage level, 41% at the server level and 37% at the UPS input.

Operators managing AI workloads are leveraging a diverse range of cooling technologies to address heat removal challenges. Among these respondents, 49% use two-phase immersion cooling, 44% rely on air cooling, 42% employ two-phase direct-to-chip solutions, 36% use single-phase direct-to-chip cooling and 33% have adopted single-phase immersion cooling. Among those who use direct-to-chip installations, 90% still need to combine them with air-cooling technology.

CONTACTS

Americas: +1 800 597 1344

Asia-Pacific: +60 4 296 1125

Europe, Middle East, Africa: +44 (0) 203 367 0681

www.spglobal.com/energy

www.spglobal.com/en/enterprise/about/contact-us.html

©2026 by S&P Global Inc. All rights reserved.

S&P Global, the S&P Global logo, S&P Global Energy, and Platts are trademarks of S&P Global Inc. Permission for any commercial use of these trademarks must be obtained in writing from S&P Global Inc.

You may view or otherwise use the information, prices, indices, assessments and other related information, graphs, tables and images (“Data”) in or on this report only for your personal use or, if you or your company has a license for the Data from S&P Global Energy and you are an authorized user, for your company’s internal business use only. You may not publish, reproduce, extract, distribute, retransmit, resell, create any derivative work from, use in any artificial intelligence system, and/or otherwise provide access to the Data or any portion thereof to any person (either within or outside your company, including as part of or via any internal electronic system or intranet), firm or entity, including any subsidiary, parent, or other entity that is affiliated with your company, without S&P Global Energy’s prior written consent or as otherwise authorized under license from S&P Global Energy. Any use or distribution of the Data beyond the express uses authorized in this paragraph above is subject to the payment of additional fees to S&P Global Energy.

S&P Global Energy, its affiliates and all of their third-party licensors disclaim any and all warranties, express or implied, including, but not limited to, any warranties of merchantability or fitness for a particular purpose or use as to the Data, or the results obtained by its use or as to the performance thereof. Data in this publication includes independent and verifiable data collected from actual market participants. Any user of the Data should not rely on any information and/or assessment contained therein in making any investment, trading, risk management or other decision. S&P Global Energy, its affiliates and their third-party licensors do not guarantee the adequacy, accuracy, timeliness and/or completeness of the Data or any component thereof or any communications (whether written, oral, electronic or in other format), and shall not be subject to any damages or liability, including but not limited to any indirect, special, incidental, punitive or consequential damages (including but not limited to, loss of profits, trading losses and loss of goodwill).

ICE index data and NYMEX futures data used herein are provided under S&P Global Energy’s commercial licensing agreements with ICE and with NYMEX. You acknowledge that the ICE index data and NYMEX futures data herein are confidential and are proprietary trade secrets and data of ICE and NYMEX or its/their licensors/suppliers, and you shall use best efforts to prevent the unauthorized publication, disclosure or copying of the ICE index data and/or NYMEX futures data.

Permission is granted for those registered with the Copyright Clearance Center (CCC) to copy material above for internal reference or personal use only, provided that appropriate payment is made to the CCC, 222 Rosewood Drive, Danvers, MA 01923, phone +1-978-750-8400. Reproduction in any other form, or for any other purpose, is forbidden without the express prior permission of S&P Global Inc. For article reprints contact: The YGS Group, phone +1-717-505-9701 x105 (800-501-9571 from the U.S.).

For all other queries or requests pursuant to this notice, please contact S&P Global Inc. via email at support.energy@spglobal.com.